

07-21-2003



To the Honorable Commissioner of Patents 102501796

and original document or copy thereof.

1. Name of conveying party

- 1) YUKIO SAKASHITA
2)
3)
4)
5)
6)

7-17-03

Additional names of conveying parties attached? ☐ Yes ☒ No

2. Name and address of receiving party:

Name: TDK CORPORATION

Internal Address: _____

Street Address: 1-13-1, NIHONBASHI

TOKYO

Postal Code & City: 103-8272, CHUO-KU

Country JAPAN

Additional names & addresses attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Dates:

- 1) JULY 8, 2003 4) _____
2) _____ 5) _____
3) _____ 6) _____

4. Application number(s) or registration number(s):

If this document is being filed together with a new application,
the filing date of the application is _____.

A. Patent Application No(s).

10/375,923

B. Patent No(s).

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Seed Intellectual Property Law Group PLLC

Internal Address: DAVID V. CARLSON

Street Address: 701 Fifth Avenue, Suite 6300

City: Seattle State: WA ZIP: 98104-7092

6. Total number of applications and patents involved.....1

7. Total Fee (37 CFR 3.41):\$40

☒ Enclosed☐ Authorized to be charged to deposit account

(Attach duplicate copy of this page if paying by deposit account)

8. Deposit account number:

19-1090

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

DAVID V. CARLSON

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and document:

3

ASSIGNMENT

WHEREAS, I Yukio SAKASHITA (hereinafter referred to as ASSIGNOR), having mailing addresses of c/o TDK Corporation, 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan respectively, am the solo inventor of an invention entitled "MULTI-LAYERED UNIT," as described and claimed in the specification for which an application for United States letters patent was filed on February 26, 2003, and assigned Application No. 10/375,923.

WHEREAS, TDK Corporation (hereinafter referred to as ASSIGNEE), a corporation of the Country of Japan having a place of business at 1-13-1, Nihonbashi, Chuo-ku, Tokyo, 103-8272, Japan, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR hereby sell, assign and transfer unto said ASSIGNEE, the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR had this assignment, transfer and sale not been made. ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR agrees to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefor.

July 8, 2003

Yukio Sakashita

Date

Yukio SAKASHITA

Witness_____

Date_____

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